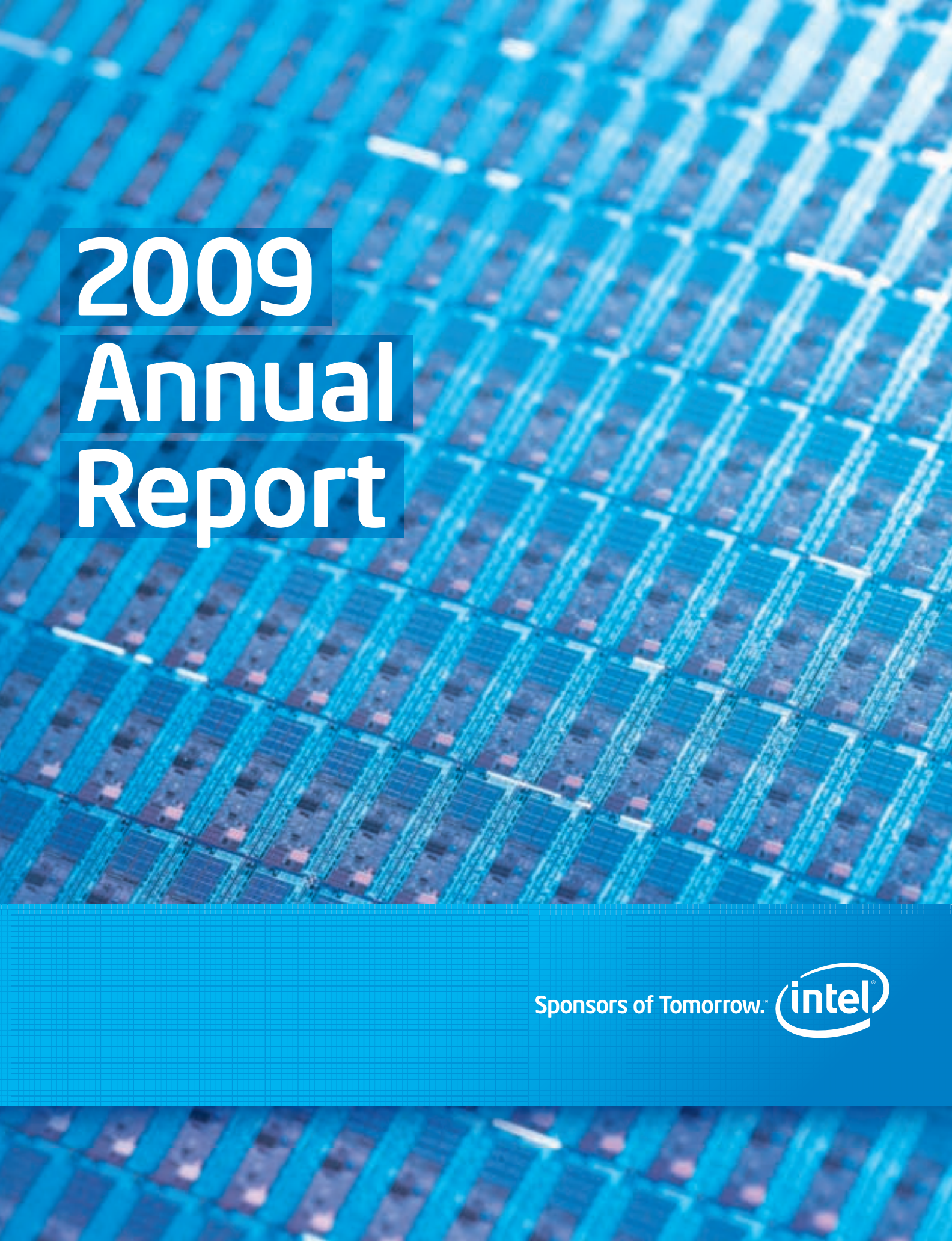
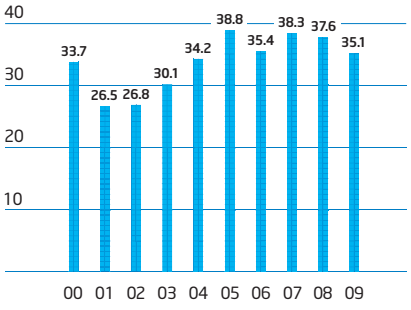

2009
Annual
Report
Sponsors of Tomorrow.™
intel

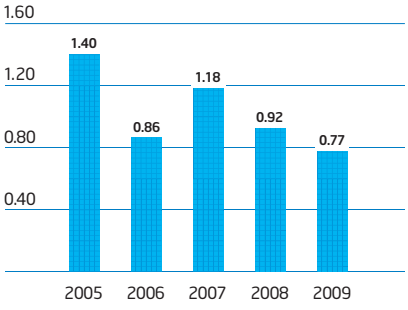
Financial Results

Sponsors of Tomorrow.™

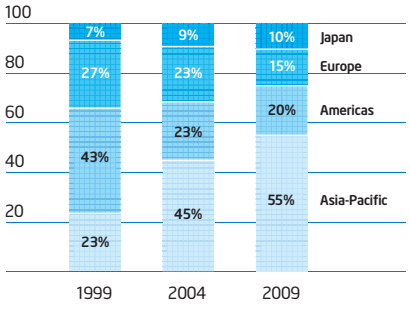
Net Revenue
Dollars in billions



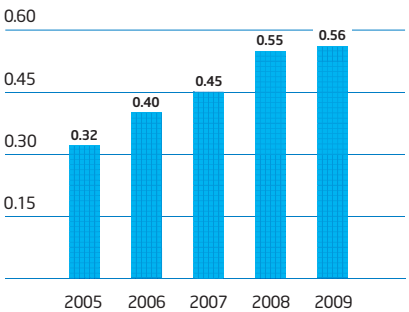
Diluted Earnings Per Share
Dollars



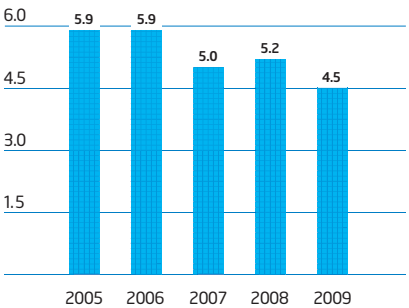
Geographic Breakdown of Revenue
Percent



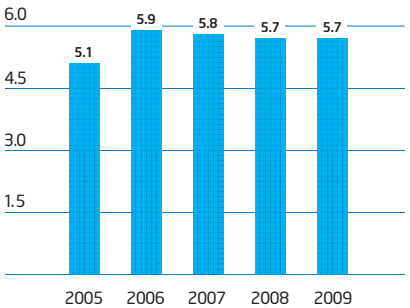
Dividends Per Share Paid
Dollars



Capital Additions to Property, Plant and Equipment
Dollars in billions



Research and Development
Dollars in billions



"Intel's strong 2009 results reflect our investment in industry-leading manufacturing and product innovation. This strategy has enabled us to generate unprecedented operating efficiencies while growing our traditional business and creating exciting new market opportunities, even in difficult economic times."

Paul S. Otellini, President and Chief Executive Officer

Past performance does not guarantee future results. This Annual Report to Stockholders contains forward-looking statements, and actual results could differ materially. Risk factors that could cause actual results to differ are set forth in the "Risk Factors" section and throughout our 2009 Form 10-K, which is included in this Annual Report.

Letter From Your CEO

We entered 2009 in one of the deepest recessions in our history, and ended it with broad-based demand for our products across all regions and market segments. We reported 2009 revenue of $35.1 billion, operating income of $5.7 billion, net income of $4.4 billion, and earnings per share of 77 cents. We generated more than $11 billion in cash from operations, and ended the year with $13.9 billion in cash, short-term investments, and trading assets. Our cash dividend payout for 2009 totaled $3.1 billion, and we announced a 12.5% increase in our cash dividend beginning in the first quarter of 2010.

Indispensable products

Despite the worldwide economic recession, microprocessor unit shipments for the PC industry were up 6% in 2009, according to Mercury Research—illustrating how essential computing has become in our lives. As the year progressed, we saw increasingly strong consumer market sales—fueled in large part by the popularity of mobile computers, including easy-to-use, affordable Intel® Atom™ processor-based netbooks. Our revenue for Intel Atom processors and associated chipsets totaled $1.4 billion in 2009.

We are also pleased with the rapid acceptance of our newer processors in the server market segment, where enterprises are increasingly replacing many older servers with a single system based on our latest generation, energy-efficient Intel® Core™ microarchitecture to achieve better performance, save space, and reduce energy costs.

Growth areas

Driven by the Intel Atom processor, the spectrum of products based on Intel® architecture is expanding beyond PCs and servers to include handhelds, consumer electronics devices, and hundreds of embedded applications. In 2009, we signed agreements with LG Electronics and Nokia to collaborate on development of Intel Atom processor-based mobile devices.

Our goal is to deliver a great "personal" computing experience across all types of devices, and to enable consumers to move seamlessly from one type of device to another. Recognizing that software is key to making this happen, in 2009 we acquired Wind River Systems, a leading developer of embedded device software, to grow our software capabilities. Wind River will operate as a wholly owned subsidiary, bringing software expertise that we believe will accelerate our development into new areas of business. In September, we also launched the Intel® Atom™ Developer Program, which provides tools and infrastructure to help independent software vendors develop and market applications for netbooks initially, and then expanding to a broader range of devices.

New generations of technology

Innovation throughout the computing spectrum is possible because of Intel's ability to develop successive generations of manufacturing process technology that enable us—year after year—to build microprocessors that can cost less to manufacture, have improved performance and energy efficiency, and offer more capabilities. We now produce a substantial majority of our microprocessors using 45-nanometer (nm) process technology, and we have achieved high-volume production of the first products based on our leading-edge 32nm process technology. We have also already demonstrated the world's first 22nm process technology, on track for production in 2011.

Legal matters

Our 2009 results reflect the impact of a $1.45 billion fine that we incurred in May as a result of the European Commission conclusion that Intel had violated competition laws in Europe. We strongly believe that the decision was wrong and are appealing it. Our results were also affected by a $1.25 billion payment that we made in November to Advanced Micro Devices (AMD) as part of a settlement to end all outstanding legal issues between the companies, including antitrust litigation and cross-license patent disputes. The settlement is a compromise of disputed legal matters, with both companies denying any wrongdoing. It avoided a lengthy and complex jury trial in Delaware, where AMD would have sought multiples of the amount paid to settle these claims. In the fall of 2009, both the New York Attorney General and the U.S. Federal Trade Commission also filed antitrust lawsuits against Intel—actions that we believe are misguided, wrong on the facts, and based on incomplete investigations. We firmly believe that Intel has competed fairly and lawfully, and we will continue to litigate these cases.

Corporate responsibility leadership

We are a recognized leader in corporate responsibility. Intel was named one of the World's Most Ethical Companies by Ethisphere Institute, and was also included in the Dow Jones Sustainability Index for the 11th year in a row. Newsweek ranked Intel among the top five on its Green Rankings 2009 list of the 500 largest corporations in America, citing our focus on building energy-efficient products and our standing as the largest corporate purchaser of renewable energy in the U.S. We believe that technology is key to addressing the world's environmental challenges, and continue to design our products with energy efficiency in mind. We estimate, in fact, that the conversion to the energy-efficient Intel Core microarchitecture saved up to 26 terawatt-hours of electricity between 2006 and 2009, compared to the technology it replaced.

Operational excellence

Throughout 2009, we maintained a focus on efficiency and tight spending controls across all of our operations. In particular, our factories executed well, with improvements in throughput times and yields, and lower unit costs across most lines of business. The comprehensive restructuring effort that we began in 2006 had resulted in cumulative savings of more than $4.9 billion by the end of the year.

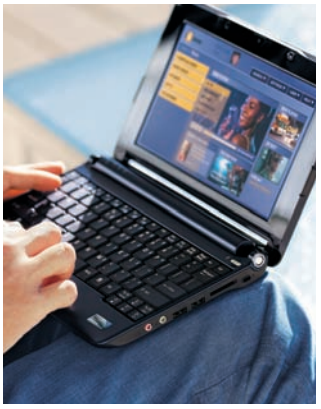
The Intel Sponsors of Tomorrow™ marketing campaign turns the spotlight on the people responsible for our ongoing record of operational excellence—Intel's employees. I would like to thank them for their outstanding performance through the challenges and triumphs of 2009. They are innovators in the truest sense of the word—the rock stars of our industry.

Paul S. Otellini, President and Chief Executive Officer

2009 Highlights

Intel Sponsors of Tomorrow.™

A major marketing campaign launched in 2009 celebrates Intel employees—and the passion for innovation, quest for perfection, respect for geekiness, and strong sense of humor that pervade our company culture.



Growth Opportunities

The range of computing products based on Intel® architecture is expanding beyond PCs and servers to netbooks, handhelds, consumer electronics devices, and more.

Commitment to Education

Intel is actively involved in education, advocacy, and technology access programs to help give students around the world the opportunity to become the next generation of innovators.

Technology Leadership

We have launched the first products based on our leading-edge 32nm manufacturing process technology, and have already demonstrated the world's first 22nm process technology, on track for production in 2011.

Letter From Your Chairman

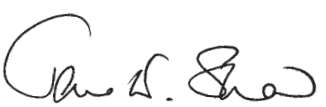
After 17 years on the Intel Board of Directors, it has been an honor and a privilege to assume the role of Intel Chairman. As an independent chairman, I look forward to supporting Paul Otellini and the other members of Intel's executive team, and ensuring that the Board continues to be a role model for excellence in corporate governance.

Intel remains strongly committed to operating with the highest level of integrity; open and direct communication is a hallmark of the Intel culture, including listening to and responding to stakeholders' concerns. In 2009, for example, in response to a stockholder proposal, the Board adopted a "say on pay" advisory vote on executive compensation, increasing stockholders' opportunity to provide feedback on Intel's compensation practices.

In an effort to further increase transparency, Intel has added several "virtual" components to the company's annual stockholders' meeting. Stockholders who cannot attend the annual meeting in person have had the opportunity to attend via the Internet for many years. Intel has expanded this functionality to allow stockholders to submit questions online prior to the meeting, and ask questions and cast votes online during the meeting. We believe that enabling stockholders from around the world to attend the annual meeting virtually allows for their increased participation and access to management.

In 2009, Intel extended its unwavering commitment to corporate responsibility. Intel joined the United Nations Global Compact, and published a set of Human Rights Principles that express the company's dedication to human rights and responsible labor practices—not only at Intel, but throughout its supply chain. The company continued its focus on improving the quality of education around the world, reaching the milestone of providing technology training to 7 million teachers through the Intel® Teach Program. Building on Intel's strong culture of volunteerism, the company formed the Intel Education Service Corps, which trains groups of employee volunteers and sends them to developing countries to facilitate installation of Intel-powered classmate PCs in schools, orphanages, and other locations. They also provide technology training for local students, teachers, and parents. Their work has the potential to change the lives of thousands of people.

Since I assumed the role of Intel Chairman in May 2009, I have enjoyed the opportunity to interact more closely with Intel employees at all levels. Several of them have remarked how inspired they are by my role as one of the few female independent chairmen of an S&P 500 company. I, in turn, am inspired by the energy, enthusiasm, and talent displayed by the women and men who work at Intel. There isn't a problem they won't tackle, and I witness examples of their flawless planning and execution day after day. I look forward to the future they are creating for all of us.



Jane E. Shaw, Chairman of the Board

Corporate Directory

BOARD OF DIRECTORS

Ambassador Charlene Barshefsky [5†]
Senior International Partner
Wilmer Cutler Pickering Hale and Dorr LLP
A multinational law firm

Susan L. Decker [1† 5]
Entrepreneur-in-Residence
Harvard Business School

John J. Donahoe [1 5]
President and
Chief Executive Officer
eBay Inc.

Reed E. Hundt [2 3]
REH Advisors
A strategic advice firm

Paul S. Otellini [4]
President and
Chief Executive Officer

James D. Plummer [1 5]
John M. Fluke Professor
of Electrical Engineering
Frederick E. Terman Dean
of the School of Engineering
Stanford University

David S. Pottruck [2† 4]
Chairman and
Chief Executive Officer
Red Eagle Ventures, Inc.
A San Francisco private equity firm

Jane E. Shaw [1 3 4†]
Chairman of the Board

John L. Thornton [2 3]
Professor and
Director of Global Leadership
Tsinghua University (Beijing)

Frank D. Yeary [1 5]
Vice Chancellor
University of California, Berkeley

David B. Yoffie [2 3†]
Max and Doris Starr
Professor of International
Business Administration
Harvard Business School

FORMER CHIEF EXECUTIVE OFFICERS AND CHAIRMEN OF THE BOARD

Gordon E. Moore
Co-Founder
Retired Chief Executive Officer
and Chairman of the Board

Andrew S. Grove
Senior Advisor
Retired Chief Executive Officer
and Chairman of the Board

Craig R. Barrett
Retired Chief Executive Officer
and Chairman of the Board

[1] *Member of Audit Committee*

[2] *Member of Compensation Committee*

[3] *Member of Corporate Governance and Nominating Committee*

[4] *Member of Executive Committee*

[5] *Member of Finance Committee*

[†] *Committee Chairman*

CORPORATE OFFICERS

Paul S. Otellini
President and
Chief Executive Officer

Andy D. Bryant
Executive Vice President
Technology, Manufacturing,
and Enterprise Services
Chief Administrative Officer

Sean M. Maloney
Executive Vice President
General Manager,
Intel® Architecture Group

David Perlmutter
Executive Vice President
General Manager,
Intel® Architecture Group

Arvind Sodhani
Executive Vice President
President, Intel Capital

Robert J. Baker
Senior Vice President
General Manager,
Technology and
Manufacturing Group

Anand Chandrasekher
Senior Vice President
General Manager,
Ultra-Mobility Group

William M. Holt
Senior Vice President
General Manager,
Technology and
Manufacturing Group

Renee J. James
Senior Vice President
General Manager,
Software and Services Group

Thomas M. Kilroy
Senior Vice President
General Manager,
Sales and Marketing Group

Eric B. Kim
Senior Vice President
General Manager,
Digital Home Group

Brian M. Krzanich
Senior Vice President
General Manager,
Manufacturing and Supply Chain

A. Douglas Melamed
Senior Vice President
General Counsel

Patricia Murray
Senior Vice President
Director, Human Resources

Stacy J. Smith
Senior Vice President
Chief Financial Officer

Sohail U. Ahmed
Vice President
Director,
Logic Technology Development

Diane M. Bryant
Vice President
Chief Information Officer

Louis J. Burns
Vice President
General Manager,
Digital Health Group

Douglas F. Busch
Vice President
Chief Technology Officer,
Digital Health Group

Deborah S. Conrad
Vice President
General Manager,
Corporate Marketing Group

Robert B. Crooke
Vice President
General Manager, Intel® Atom™
and System-on-Chip
Development Group

Leslie S. Culbertson
Vice President
Director, Finance

Shmuel Eden
Vice President
General Manager, PC Client Group

Ron Friedman
Vice President
General Manager, Microprocessor
and Chipset Development

Ravi Jacob
Vice President
Treasurer

John N. Johnson
Vice President
Chief Information Officer

Justin R. Rattner
Vice President
Director, Intel Labs
Intel Chief Technology Officer

Stephen L. Smith
Vice President
Director, Intel® Architecture
Group Operations

William A. Swope
Vice President
General Manager,
Corporate Sustainability Group

Richard G. A. Taylor
Vice President
Director, Human Resources

Cary I. Klafter
Corporate Secretary

APPOINTED VICE PRESIDENTS

Digital Health Group

Patricia N. Perry
Director, Product Delivery

Intel® Architecture Group

John D. Barton
General Manager, Platform
Validation Engineering

Rani N. Borkar
Director, Microprocessor and
Graphics Development

Daniel J. Casaletto
Director, Microprocessor
Architecture and Performance

Alan Crouch
Director, Software Engineering

Bradley D. Daniels
Director, System-on-Chip
Engineering

Douglas L. Davis
General Manager, Embedded and
Communications Group

David R. Ditzel
Chief Architect,
Hybrid Parallel Computing

Ricardo J. Echevarria
General Manager,
Business Client Platform Division

Gil G. Frostig
Director, Low Power Components,
Ultra-Mobility Group

James A. Johnson
General Manager,
Visual Computing Group

Thomas R. Macdonald
General Manager,
Platform Components Group

Richard Malinowski
General Manager,
Client Components Group

Rory M. McInerney
Director, Microprocessor and
Graphics Group

Raviv Melamed
General Manager,
Mobile Wireless Group

W. Eric Mentzer
Director, Visual
Computing Architecture,
Visual Computing Group

Alexander D. Peleg
Director, Intel® Architecture
Strategic and Platform
Planning and Corporate
Platform Initiatives Office

Prasad L. Rampalli
Director,
End-User Platform Integration

Clemente J. Russo
General Manager,
Intel Client Boards Division

Sunil R. Shenoy
General Manager, Microprocessor
and Graphics Development

Rama K. Shukla
Director, WiMAX Program Office

Gadi Singer
General Manager,
System-on-Chip Enabling Group

Kirk B. Skaugen
General Manager,
Data Center Group

Ton H. Steenman
General Manager, Low Power
Embedded Products Division

Thomas H. Swinford
General Manager,
LAN Access Division

Robert P. Swinnen
Director,
Global Business Development,
Ultra-Mobility Group

Sriram Viswanathan
General Manager,
WiMAX Program Office

Shane D. Wall
Director, Strategic Planning,
Platform Architecture and
Software, Ultra-Mobility Group

Elenora Yoeli
Director, Low Power
Intel® Architecture Microprocessor
Development, Ultra-Mobility Group

Intel Capital

Keith R. Larson
Managing Director, Manufacturing
Sector, and Taiwan, Korea, and
Latin America Regions

Curt J. Nichols
Managing Director,
Digital Home Sector

Raheel A. Shah
Director, Mergers and Acquisitions

Intel Labs

Andrew A. Chien
Director,
Future Technologies Research

Vida Ilderem
Director, Integrated Platform
Research Lab

Joseph D. Schutz
Director, Microprocessor and
Programming Research

Wen-Hann Wang
Director,
Circuits and Systems Research

Abel Weinrib
Director, Intel Labs

Legal and Corporate Affairs

Peter M. Cleveland
Director, Global Public Policy

Shelly M. Esque
Director, Corporate Affairs Group
President, Intel Foundation

Cary I. Klafter
Director, Corporate Legal
Corporate Secretary

Suzan A. Miller
Deputy General Counsel

Steven R. Rodgers
Associate General Counsel
Director, Litigation

Sales and Marketing Group

Paul Bergevin
General Manager,
Global Communications Group

Nancy Bhagat
Director,
Marketing Strategy and Campaigns

Christopher J. (CJ) Bruno
President, Intel Americas, Inc.

Gregory M. Bryant
Director, Global Accounts – Lenovo

(Sophia) Lee Fan Chew
General Manager, Services

Laura G. Crone
Director, Global Accounts –
Hewlett-Packard

Tammy L. Cyphert
Director, Global Operations
and Productivity

Steven J. Dallman
General Manager, Worldwide
Reseller Channel Organization

John E. Davies
General Manager,
Intel World Ahead Program

Corporate Directory *(continued)*

Richard R. Dwyer
General Manager,
Worldwide Embedded Sales Group

Gordon G. Graylish
General Manager,
Enterprise Solutions Sales

Gerald J. Greeve
Director,
Intel World Ahead Program

Johan Jervøe
Director, Creative Services
and Digital Marketing

Jeffrey P. McCrea
Director,
Consumer Channels Group

Christian Morales
General Manager,
Europe, Middle East, Africa

Stuart C. Pann
General Manager,
Business Management Group

Gregory R. Pearson
General Manager, Worldwide Sales
and Operations Group

Arthur W. Roehm
Director, Global Accounts – Dell

Navin Shenoy
General Manager,
Asia-Pacific Region

Xu (Ian) Yang
President, Intel China Ltd.

Kazumasa Yoshida
President, Intel K.K. (Japan)

Software and Services Group

Douglas W. Fisher
General Manager,
Systems Software Division

Elliot D. Garbus
General Manager, Visual Computing
Software Division

Kostas A. Katsohirakis
Director, Strategic Business
Development

Jonathan Khazam
General Manager, Manageability
and Middleware Division

David O'Meara
Managing Director, Havok

Technology, Manufacturing, and Enterprise Services

Finance

James G. Campbell
Corporate Controller

Christina S. Min
Controller, Technology and
Manufacturing Group

Nanci S. Palmintere
Director, Global Tax and Trade

Corine Perez
Controller,
Intel® Architecture Group

R. Kevin Sellers
Director, Investor Relations

Human Resources

Ogden M. Reid
Director,
Compensation and Benefits

Information Technology

Dianne L. Rudolph
Director,
IT Business Transformation

Kumud M. Srinivasan
General Manager,
IT Core Systems Engineering

Kimberly S. Stevenson
General Manager,
IT Global Operations and Services

Technology and Manufacturing Group

Mostafa A. Aghazadeh
Director, Chandler Assembly
Technology Development

David A. Baglee
Co-Executive Officer,
IM Flash Technologies LLC**

Peng Bai
Director, Derivative Logic
Technology Development

Melton C. Bost
Director, Yield Technology

Nasser Bozorg-Grayeli
Director,
Corporate Quality Network

Craig C. Brown
Director, Materials

Robert E. Bruck
General Manager, Technology
Manufacturing Engineering

Peter Charvat
Director, PTD Patterning
and Manufacturing

Maxine Fassberg
Plant Manager, Fab 28
General Manager, Intel Israel

Gulsher S. Grewal
Plant Manager, D1DR Fab

Timothy G. Hendry
Plant Manager, Fab 11X

Franklin B. Jones
General Manager,
Customer Fulfillment,
Planning and Logistics

Michael C. Mayberry
Director, Components Research

Patricia A. McDonald
Plant Manager, Fab 20

Steven C. Megli
General Manager,
Assembly Test and Manufacturing

Kaizad R. Mistry
Director,
Logic Technology Integration

James R. OHara
General Manager,
Ireland Operations
Plant Manager,
Ireland Fab Operations

John R. Pemberton
Plant Manager, Fab 32/22

***49% owned by Intel Corporation, 51% owned by Micron Technology, Inc.*

Thomas A. Rampone
General Manager,
NAND Solutions Group

Sunit Rikhi
General Manager, Custom
Intel® Architecture Foundry

Babak Sabi
Director, Assembly Test and
Technology Development

Jacklyn A. Sturm
General Manager,
Worldwide Materials

Chi-Hwa Tsang
Director, Thin Films and Chemical
Mechanical Polish Technology

Neil R. Tunmore
Director, Corporate Services

Joshua Walden
General Manager,
Fab/Sort Manufacturing

Chiang Yuan Yang
Director, Intel Mask Operation

Siva K. Yerramilli
General Manager,
Design and Technology Solutions

SENIOR FELLOWS

Intel® Architecture Group

Peter D. MacWilliams
Staff Platform Architect

Stephen S. Pawlowski
General Manager, Central
Architecture and Planning

Intel Labs

Kevin C. Kahn
Director, Communications
Technology Lab

Justin R. Rattner
Director, Intel Labs
Intel Chief Technology Officer

Software and Services Group

Bryant E. Bigbee
Director, Systems Software

Technology, Manufacturing, and Enterprise Services

Technology and Manufacturing Group

Mark T. Bohr
Director, Process Architecture
and Integration

Yan A. Borodovsky
Director, Advanced Lithography

Robert S. Chau
Director, Transistor Research
and Nanotechnology

Richard L. Coulson
Director, I/O Architecture

Ian A. Young
Director, Advanced Circuits
and Technology Integration

FELLOWS

Digital Health Group

Eric Dishman
Director,
Health Innovation and Policy

Intel® Architecture Group

Matthew J. Adiletta
Director, Communication
Infrastructure and Architecture

Siavash M. Alamouti
Chief Technology Officer,
Mobility Wireless Group

Genevieve Bell
Director, User Experience Group,
Digital Home Group

Ajay V. Bhatt
Chief Client Architect

Fayé A. Briggs
Director,
Scalable Server Architecture

Douglas M. Carmean
Larrabee Chief Architect

John H. Crawford
Computer Architect

Joel S. Emer
Director,
Microarchitecture Research

Tryggve Fossum
Director,
Microarchitecture Development

Simcha Gochman
Director,
Future Mobile CPU Architecture

Knut S. Grimsrud
Director, Storage Architecture

Glenn J. Hinton
Director, IA-32 Microarchitecture
Development

Karl G. Kempf
Director, Decision Engineering

Rajesh Kumar
Director, Circuit and
Low Power Technologies

P. Geoffrey Lowney
Director, Compiler and Architecture
Advanced Development

Thomas A. Piazza
Director, Graphics Architecture

Shreekant Thakkar
Director, Ultra-Mobility Group
Platform Architecture

Brendan Traw
Chief Technology Officer,
Digital Home Group

Intel Labs

Shekhar Y. Borkar
Director,
Microprocessor Technology Lab

Vivek K. De
Director,
Circuit Technology Research

James P. Held
Director,
Tera-Scale Computing Research

Randy Mooeny
Director, I/O Research

Mario Paniccia
Director,
Photonics Technology Lab

Krishnamurthy Soumyanath
Director,
Communications Circuits Research

Gregory F. Taylor
Director, Circuit Research Lab

Richard A. Uhlig
Chief Virtualization Architect

Ofri Wechsler
Director, Mobility Microprocessor
Architecture

Raj Yavatkar
Director,
System-on-Chip Architecture

Legal and Corporate Affairs

David B. Papworth
Director, Microprocessor
Product Development

Software and Services Group

Boris A. Babayan
Director, Architecture

Shivnandan D. Kaushik
Director, Systems Software

David J. Kuck
Director, Parallel and Distributed
Solutions Division

Technology, Manufacturing, and Enterprise Services

Technology and Manufacturing Group

Albert Fazio
Director, Memory Technology
Development

Paolo A. Gargini
Director, Technology Strategy

Tahir Ghani
Director, Transistor Technology
and Integration, Portland
Technology Development

Kelin J. Kuhn
Director,
Advanced Device Technology

Jose A. Maiz
Director, Logic Technology
Quality and Reliability

Neal R. Mielke
Director, Reliability Methods

Devadas D. Pillai
Director, Operational Decision
Support Technology

Valluri R. Rao
Director, Analytical and
Microsystems Technologies

Vivek K. Singh
Director,
Computational Lithography

Swaminathan Sivakumar
Director, Lithography

Joseph M. Steigerwald
Director, Chemical Mechanical
Polish Technology

Clair Webb
Director, Circuit Technology

Kevin X. Zhang
Director, Advanced Design

Investor Information

Investor materials. Intel's Investor Relations web site contains background on our company and our products, financial information, frequently asked questions, and our online annual report, as well as other useful information. For investor information, including additional copies of our annual report/10-K, 10-Qs, or other financial literature, visit our web site at *www.intc.com* or call Intel at (408) 765-1480 (U.S.); (44) 1793 403 000 (Europe); (852) 2844 4555 (Hong Kong); (81) 298 47 8511 (Japan).

Intel on NASDAQ. Intel's common stock trades on The NASDAQ Global Select Market* under the symbol INTC.

Direct stock purchase plan. Intel's Direct Stock Purchase Plan allows stockholders to reinvest dividends and purchase Intel common stock on a weekly basis. For more information, contact Intel's transfer agent, Computershare Investor Services, LLC, by phone at (800) 298-0146 (U.S. and Canada) or (312) 360-5123 (worldwide), or by e-mail through Computershare's web site at *www.computershare.com/contactus*.

Transfer agent and registrar. Computershare Investor Services, LLC, 250 Royall Street, Mail Stop 1A, Canton, MA 02021 USA. Stockholders may call (800) 298-0146 (U.S. and Canada) or (312) 360-5123 (worldwide), or send e-mail through Computershare's web site at *www.computershare.com/contactus* with any questions regarding the transfer of ownership of Intel stock.

Independent registered public accounting firm. Ernst & Young LLP, San Jose, California, USA.

The Intel® brand. The Intel brand is consistently ranked as one of the most recognizable and valuable brands in the world. It represents our commitment to moving technology forward and is the embodiment of what we make possible for people everywhere. As the world leader in semiconductor technology, we relentlessly focus on industry leadership, innovation, and growth. Our microprocessors and continuous innovation help extend what people do with technology.

Corporate responsibility disclosure. Detailed information on our corporate responsibility and environmental sustainability performance is published annually each May. Intel's Corporate Responsibility Report, prepared using the Global Reporting Initiative's G3 Sustainability Reporting Guidelines, details our strategic priorities and performance on a wide variety of environmental, social, and governance factors, including workplace practices, community engagement, and supply chain responsibility initiatives. The report and supporting materials are available on our web site at *www.intel.com/go/responsibility*.

Environmental performance. Intel is a recognized leader in sustainability for the ways we work to minimize the environmental impacts of our operations, and design products that use less harmful materials and are more energy efficient. We believe that technology is fundamental to finding solutions to the world's environmental challenges. In 2009, for the second year in a row, Intel was named a Green Power Partner of the Year by the U.S. Environmental Protection Agency in recognition of our multi-year commitment to purchase more than 1.3 billion kilowatt-hours of renewable energy certificates each year, which represents approximately 50% of Intel's annual U.S. electricity use. As part of our effort to further integrate sustainability into the culture at Intel, we continued to include an environmental component in the formula used to determine the payout for employee variable compensation. We also continued to collaborate with others to drive global standards for products and manufacturing that ensure energy-efficient performance. Complete information is available at *www.intel.com/intel/environment*.

Education initiatives. Intel believes that students everywhere deserve the skills needed to succeed in a knowledge-based economy. As part of our efforts to improve teaching and learning through the effective use of technology, and advance math, science, and engineering education, Intel and the Intel Foundation invest approximately $100 million annually in programs around the world—from professional development for teachers to premier science and engineering fairs. In 2009, we reached more than 1 million teachers through the Intel® Teach Program; since its inception in 1999, Intel Teach has reached more than 7 million teachers in over 50 countries. Complete information is available at *www.intel.com/intel/education*.

The Intel World Ahead Program extends Intel's efforts to advance progress in accessibility, connectivity, content, and education in the world's developing communities, with a focus on advancing knowledge and skills development, job growth, and quality of life. Our goals also include developing PCs tailored to local needs, driving critical connectivity, cultivating sustainable local capabilities, and providing the education needed to make a difference in people's lives. More information is available at *www.intel.com/intel/worldahead*.

Governance and ethics. Intel is committed to the highest standards of business ethics and corporate governance. In 2009, Intel became a member of the United Nations Global Compact and published new Human Rights Principles to reinforce our commitment to corporate citizenship. We are also committed to promoting effective governance and responsibility in our supply chain, communicating our expectations to our own suppliers, and working collaboratively with others in our industry through the Electronic Industry Citizenship Coalition. Our Corporate Governance Guidelines, Code of Conduct, and other related policies are available at *www.intel.com/go/responsibility*.

Awards and recognitions. Each year, Intel receives numerous awards and accolades from around the world for our business practices and work in education, environmental sustainability, the community, and overall corporate citizenship. In 2009, Fortune featured Intel in its World's Most Admired Companies and its 25 Top Companies for Leaders lists, and Ethisphere Institute named Intel one of the World's Most Ethical Companies. Intel was included in the Dow Jones Sustainability Index for the 11th consecutive year, and debuted in the top five in Newsweek's inaugural ranking of the 500 greenest companies in the U.S. Information on additional awards is available at *www.intel.com/intel/corpresponsibility/awards.htm*.

Intel, Intel logo, Intel Atom, Intel Core, and Intel Sponsors of Tomorrow are trademarks of Intel Corporation in the U.S. and other countries. *Other names and brands may be claimed as the property of others.
♻ Printed on recycled paper with soy-based inks. Printed in the USA. 0410/180K/PS/MB/LM/BO. Copyright © 2010, Intel Corporation. All rights reserved.

For news and information about Intel® products and technologies, customer support, careers, worldwide locations, and more, visit **www.intel.com**

For stock information, earnings and conference webcasts, annual reports, and corporate governance and historical financial information, visit **www.intc.com**

Sponsors of Tomorrow.™